

REAL TIME CLOCK MODULE (SPI-Bus)

Built-in external event detection.

RX-4575 LC

•Built in frequency adjusted 32.768 kHz crystal unit.

•Interface Type : 3-wire serial interface

: 1.6 V ~ 5.5 V Operating voltage range •Wide timekeeper voltage range : 1.3 V ~ 5.5 V •Low backup current : 0.35 μA / 3 V (Typ.)

•External event detection. : Chattering free input port ×2.

(The various functions include full calendar, alarm, timer.)



Product Number (Please contact us) RX-4575LC: Q414575C2000100



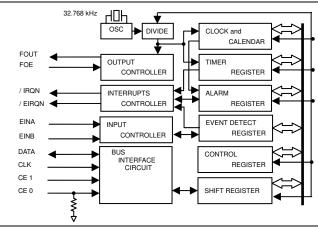




Actual size

K forb Areas

Block diagram



Overview

· Event detection.

- · Selectable Hi detection or Lo detection.
 - · Recognition of detection is available both the hardware interrupt and the monitor via software.
 - · Automatic interrupt release mode is available.
- The all 'OR' interrupt output is possible via alarm, timer and event detection.

· Performance of event input terminal.

- · As for the chattering filter,
 - following are prepared for. (8 ms, 31 ms, 62 ms, 125 ms)
- · Built-in resistor connect and release is possible via software. Selectable pull-up or pull-down.

• Timer function

- · Built in 12 bit counter.
- Timing period are 1 min, 1 s, 64 Hz, 4096 Hz.

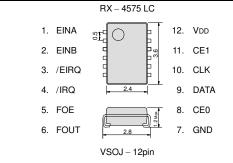
Alarm function

 Alarm setting is possible by combination of a day, hours, and minutes.

Pin Function

| Signal Name | Input / Output | Functions |
|--------------|----------------|---|
| EINA EINB | Input | External event input pin. |
| CE 0 CE 1 | Input | Interface is possible when both CE0 and CE1 is high level. |
| CLK | Input | Serial Clock input pin. |
| DATA | Bidirectional | Data input and output pin. |
| FOUT | Output | 32.768 kHz clock output pin (C-MOS) . Output is Hi-Z when OFF. |
| FOE | Input | 32kHz is output when input is Hi, 32 kHz is OFF when input is Lo. |
| / EIRQ | Output | Interrupt output pin. (N-ch open drain) |
| / IRQ | Output | Interrupt output pin. (N-ch open drain) |
| VDD | _ | Connected to a positive power supply. |
| GND | _ | Connected to a ground. |

Terminal connection / External dimensions (Unit:mm)



*Stop using the glue

Any glue must never use it after soldering LC-package to a circuit board. This product has glass on the back side of a package. When glue invasions between circuit board side and glass side, then glass cracks by thermal expansion of glue. In this case a crystal oscillation stops. Consider glue abolition or glue do not touch to LC-package

Specifications (characteristics)

■ Recommended Operating conditions

| The commence of the commence o | | | | | | |
|--|--------|-------------------|-----|------|------|------|
| Item | Symbol | Symbol Conditions | | Тур. | Max. | Unit |
| Power voltage | VDD | - | 1.6 | 3.0 | 5.5 | V |
| Clock voltage | Vclk | =- | 1.3 | 3.0 | 5.5 | V |
| Operating Temperature | Topr | - | -40 | +25 | +85 | ô |

■ Frequency characteristics

| Item | Symbol | Conditions | Rating | Unit |
|---------------------|--------------|---|-------------|--------------------|
| Frequency tolerance | Δf/f | Ta = +25 °C VDD = 3.0 V | B: 5 ± 23 * | × 10 ⁻⁶ |
| Oscillation | t sta | Ta = +25 °C VDD = 1.6 V | 1 Max. | S |
| Start-up time | | $T_a = -40 ^{\circ}\text{C} \sim +85 ^{\circ}\text{C}$ $V_{DD} = 1.6 ^{\circ}\text{V}$ | 3 Max. | s |

^{*}Equivalent to 1 minute of monthly deviation

* Refer to application

Current concumption characteristics

| Current consumption characteristics | | | | Ta = -40 °C ~ +85 °C | | | | |
|-------------------------------------|--------|---|--------------------------|----------------------|------|------|----|--|
| Item | Symbol | Conditions | Min. | Тур. | Max. | Unit | | |
| Current Consumpti on | Івк | CE0, CE1 = GND / IRQ, / EIRQ= OFF | V _{DD} = 5 V | 1 | 0.45 | 0.9 | | |
| | | FOUT : output OFF Event detection OFF | V _{DD} = 3 V | - | 0.35 | 0.7 | μА | |
| | 132k | CE0, CE1 = GND / IRQ, / EIRQ= OFF FOUT ; CL = 30 pF 32.768 kHz output ON | V _{DD} = 5 V | - | 8.0 | 20.0 | | |
| | | | V _{DD} = 3 V | 1 | 5.0 | 12.0 | μA | |

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At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

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ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



- ► Complies with EU RoHS directive.
 - *About the products without the Pb-free mark.

 Contains Pb in products exempted by EU RoHS directive.

 (Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.



▶ Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).

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